

N-Channel 700V (D-S) Super Junction Power MOSFET

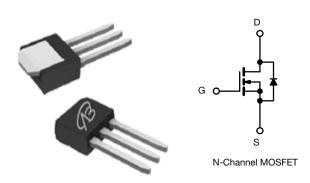
PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.550			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)



TO-251



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	700	V	
Gate-source voltage			V_{GS}	± 30	V	
Continuous drain current (T,I = 150 °C)	V at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	I-	8		
Continuous drain current (1 j = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	5	Α	
Pulsed drain current ^a			I _{DM}	24		
Linear derating factor				1.7	W/°C	
Single pulse avalanche energy b			E _{AS}	370	mJ	
Maximum power dissipation			P_{D}	190	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125$ °C		dV/dt	50	- V/ns		
Reverse diode dV/dt ^d			5.1			
Soldering recommendations (peak temperature) ^c For 10 s		10 s		260	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 100 V, starting T_J = 25 °C, L = 30 mH, R_g = 25 Ω , I_{AS} = 8.0 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	0.65	C/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		700	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	1.08	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Oala a sa la la la sa		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA
-		V _{DS} =	= 700 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 560 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D =2.5 A	-	0.550	-	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 2.5 A	-	8.7	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2600	-	
Output capacitance	C _{oss}	1	$V_{DS} = 100 \text{ V},$	-	81	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	9	-	
Effective output capacitance, energy related ^a	$C_{o(er)}$			-	58	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	V _{DS} = 0 V	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		296	-	
Total gate charge	Qg		V _{GS} = 10 V		43	122	
Gate-source charge	Q _{gs}	V _{GS} = 10 V			16	-	nC
Gate-drain charge	Q _{gd}	1 " "		-	20	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 480 V, I _D = 5 A,		-	22	44	
Rise time	t _r			-	24	48	
Turn-off delay time	t _{d(off)}		$V_{DD} = 480 \text{ V}, I_D = 3 \text{ A},$ $V_{GS} = 10 \text{ V}, R_a = 9.1 \Omega$		71	142	ns
Fall time	t _f			-	26	52	
Gate input resistance	R_g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8	A
Pulsed diode forward current	I _{SM}			-	-	24	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 5 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	416	832	ns
Reverse recovery charge	Q _{rr}			-	6.4	12.8	μC
Reverse recovery current	I _{RRM}			_	27	-	A

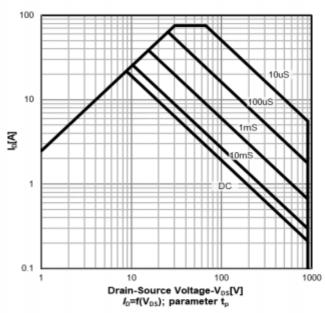
Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

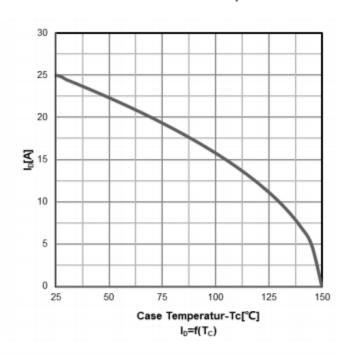


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

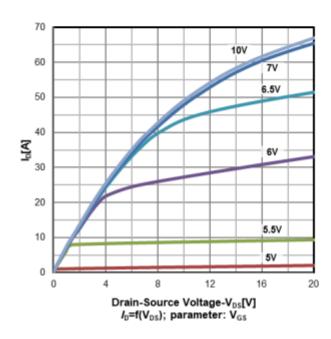
Safe operating area TC=25 °C Non FullPAK



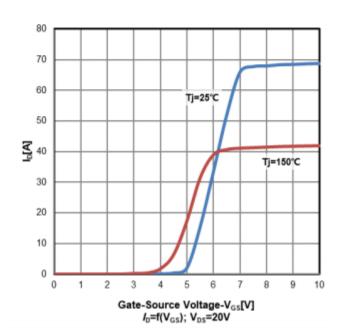
Drain current vs temperature



Typ. output characteristics T_i =25 $^{\circ}C$

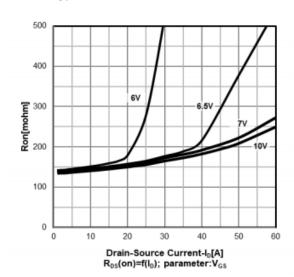


Typ. transfer characteristics

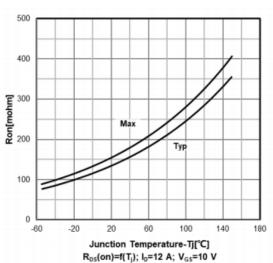




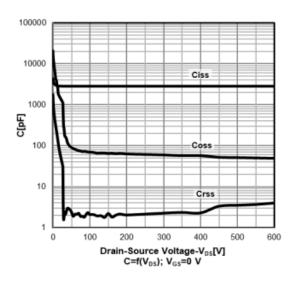
Typ. drain-source on-state resistance



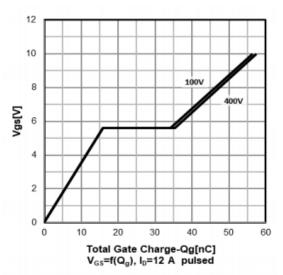
On resistance vs temperature



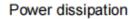
Typ. capacitances

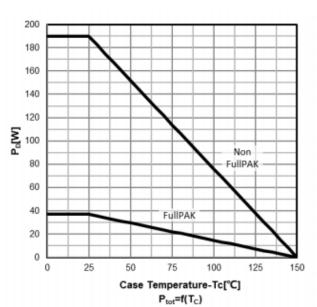


Typ. gate charge characteristics

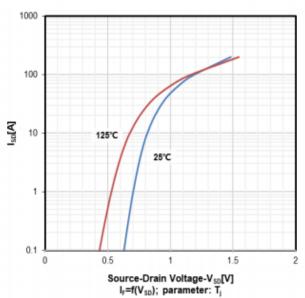




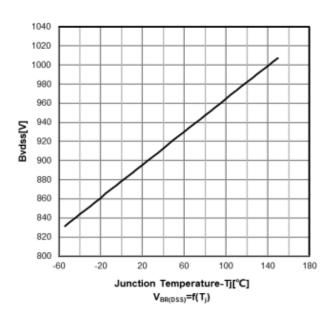




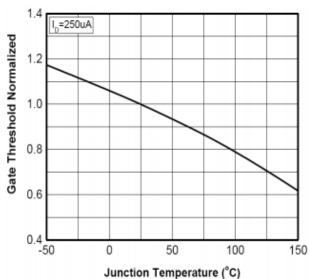
Forward characteristics of reverse diode



Drain-source breakdown voltage



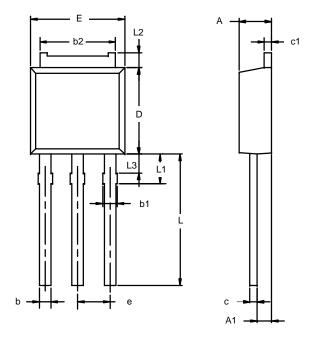
Normalized $V_{\text{GS(th)}}$ characteristics



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Note:	Dimension	L3 is for	reference	only.
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	MILLIM	IETERS	INC	HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A 1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
с1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28 BSC		0.090	BSC
L	8.89	9.53	0.350	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060



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